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(71) Applicant: THE PROCTER & GAMBLE COMPANY [US/US]; One Procter & Gamble Plaza, Cincinnati, OH 45202 (US).			
(72) Inventors: TROKHAN, Paul, Dennis; 1356 Warvel Road, Hamilton, OH 45013 (US). POWERS, John, Robert; 5743 Chesterfield Court, Fairfield, OH 45014 (US). MILLER, James, Daniel, II; 4108 Benkert Drive, Cincinnati, OH 45241 (US). BOUTILIER, Glenn, David; 10566 Stablehand Drive, Cincinnati, OH 45242 (US). McFARLAND, James, Robert; Apartment 13, 2508 Auburn Avenue, Cincinnati, OH 45219 (US).			
(74) Agents: REED, T., David et al.; The Procter & Gamble Company, 5299 Spring Grove Avenue, Cincinnati, OH 45217 (US).			
(54) Title: METHOD OF APPLYING A PHOTOSENSITIVE RESIN TO A SUBSTRATE FOR USE IN PAPERMAKING			
(57) Abstract			
The invention comprises a method for applying a curable resin, such as a photosensitive resin, to a substrate such as a papermaker's dewatering felt. The method comprises the steps of providing a substrate; providing a curable liquid resin; providing a second material different from the curable liquid resin; applying the second material to the substrate to occupy at least some of the voids in the substrate intermediate the first and second surfaces of the substrate; applying the curable resin to the substrate; curing at least some of the resin to provide a resin layer on the substrate; and removing at least some of the second material from the substrate, wherein at least some of the second material is removed from the substrate after applying the curable resin to the substrate.			